

User guide

About this document

This document describes the evaluation board of TLE4972, Infineon's magnetic current sensor for automotive applications with external current rail.

Scope and purpose

The evaluation board is meant to be used by the customer solely for the purpose of evaluation and testing. It is not a commercial product and shall not be used for series production. This board is thus not intend to meet any industrial specifications and shall be operated at room temperature.

Due to its purpose, the evaluation board is not subject to the same procedures as regular products regarding Returned Material Analysis (RMA), Process Change Notification (PCN) and Product Withdraw (PWD).

Intended audience

This document is written for customers who intend to use TLE4972 in current sensing applications.

Evaluation Board

This board will be used during design in, for evaluation and measurement of characteristics, and proof of datasheet specifications.

Note:

PCB and auxiliary circuits are NOT optimized for final customer design. Boards do not necessarily meet safety, EMI, quality standards (for example UL, CE) requirements.



Figure 1 TLE4972 EVAL INLAY



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1 Important notice

Important notice 1

"Evaluation Boards and Reference Boards" shall mean products embedded on a printed circuit board (PCB) for demonstration and/or evaluation purposes, which include, without limitation, demonstration, reference and evaluation boards, kits and design (collectively referred to as "Reference Board").

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2 Safety precautions

Safety precautions 2

Note: Please note the following warnings regarding the hazards associated with development systems.



Figure 2 **Safety Precautions**

- **Warning:** Remove or disconnect power from the drive before you disconnect or reconnect wires, or perform maintenance work. Failure to do so may result in personal injury or death.
- Warning: Do not keep the programmer connected to the laptop while the board is in use in an inverter. The laptop may be damaged during the operation of the system.
- **Warning**: The evaluation board is intended to be used only in low voltage systems (\leq 50 V).
- **Caution**: The board and device surfaces of the evaluation board may become hot during testing. Hence, necessary precautions are required while handling the board. Failure to comply may cause injury. Please refer to Chapter 6.2.1.4 for an indication of the heating due to the current flow.
- **Caution**: Only personnel familiar with the drive, power electronics and associated machinery should plan, install, commission and subsequently service the system. Failure to comply may result in personal injury and/or equipment damage.
- Caution: The evaluation board contains parts and assemblies sensitive to electrostatic discharge (ESD). Electrostatic control precautions are required when installing, testing, servicing or repairing the assembly. Component damage may result if ESD control procedures are not followed. If you are not familiar with electrostatic control procedures, refer to the applicable ESD protection handbooks and guidelines.
- **Caution**: A drive that is incorrectly applied or installed can lead to component damage or reduction in product lifetime. Wiring or application errors such as undersizing the motor, supplying an incorrect or inadequate AC supply, or excessive ambient temperatures may result in system malfunction.
- **Caution**: The evaluation board is shipped with packing materials that need to be removed prior to installation. Failure to remove all packing materials that are unnecessary for system installation may result in overheating or abnormal operating conditions.



3 The board at a glance

3 The board at a glance

TLE4972 evaluation board is developed to familiarize the users with TLE4972 current sensor for design in support and evaluation purposes. The complete evaluation kit consists of this board and the programmer board, which is explained in [1]. The programmer board supplies the sensors on the evaluation board and allows a fast and easy interfacing to each sensor. If the programmer board is not used, power supply has to be provided externally by the user.

3.1 Delivery content

The delivery content consist in TLE4972 evaluation board.

3.2 Block diagram

The evaluation board includes three TLE4972 coreless magnetic current sensors for testing in three-phase systems. The evaluation board has been designed to operate safely in low voltage systems (≤50 V). It is recommended to disconnect the USB cable between the programmer and the laptop while the system is in operation, in order to avoid damages to the laptop.

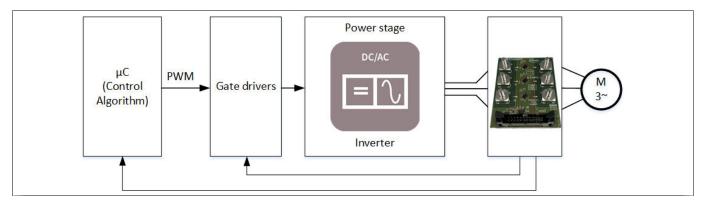


Figure 3 Block diagram of the evaluation board in use in a three-phase system

3.3 Main features

- Three TLE4972 sensors, for testing in three-phase systems;
- On board EEPROM to store board settings;
- Compatible with Infineon Current Sensor Programmer [1]

3.4 Board parameters and technical data

Table 1 Evaluation Board Overview

Product	TLE4972-AE35D5
Package	PG-TDSO-16
Evaluation board name	TLE4972 EVAL INLAY
Evaluation board order number	SP005632138
Insertion method name	45° s-bend on Schweizer Inlay PCB
Full scale (FS)	± 422.21 A
Typical current rail transfer factor	45.80 μT/A
Typical sensor sensitivity	62 mV/mT (S3)
Typical evaluation board sensitivity	2.84 mV/A
	·



3 The board at a glance

Table 1 (continued) Evaluation Board Overview

Product	TLE4972-AE35D5
Output mode	Semi-differential
OCD1 threshold	598.65 A (139% of FS)
OCD2 threshold	347.44 A (82% of FS)
Typical insertion resistance	17 μΩ
Current rail width	14 mm
Current rail thickness	1 mm



4 System and functional description

4 System and functional description

4.1 Commissioning

If the evaluation board is used in combination with the Infineon programmer board [1], it is sufficient to connect the two boards and follow the instructions on the GUI [1].

If instead the evaluation board is used as stand-alone, then the user has to supply the board with 5 V using pin 16 (positive terminal of the supply) and pin 20 or 22 (ground terminal of the supply) of the evaluation board connector. In order to enable the onboard LDO, pin 14 must be connected to 5 V as well. Please refer to Chapter 5.4 for the complete pinout of the evaluation board connector.

4.2 Description of the functional blocks

The board consists of three TLE4972 current sensors to accurately sense AC and DC currents, a EEPROM to store the board settings, a LDO (Low Drop Out) regulator to stabilize the supply voltage of the sensors and a connector to connect to the Infineon programmer board [1]. For additional information about TLE4972 please refer to the user manual [2] and datasheet [3]. Guidelines about sensing structure design are given in the dedicated application note [4].

4.3 Sensing Structure Layout & Guidelines

The three sensors are mounted on a PCB and placed on top of the current rail inside the PCB. The sensors are twisted 45° in order to reduce the crosstalk between the three phases, without compromising the frequency response of the sensor and insertion resistance of the conductor. The current rail has a 0.5 mm s-shaped slit. Please refer to the sensing structure design application note [4] for further guidelines.

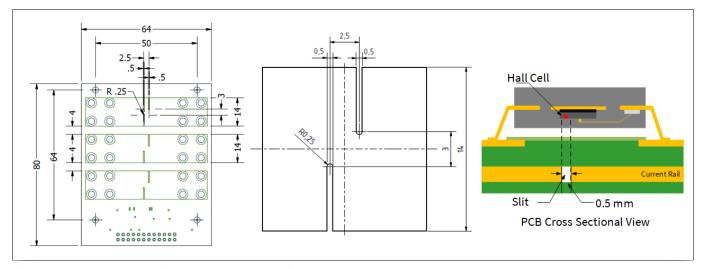


Figure 4 Sensing structure overview



5 System design

5 System design

5.1 Schematics

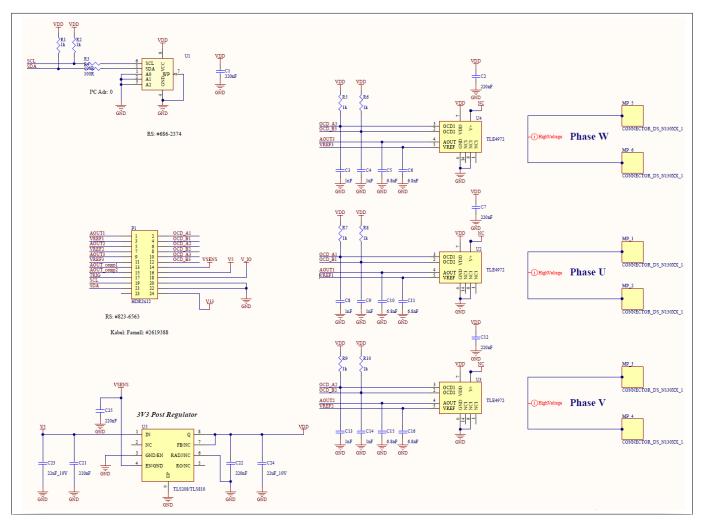


Figure 5 TLE4972 evaluation board schematic

In order to suppress the high frequency noise and meet the EMC and ESD requirements, the following capacitors have been implemented:

- A 220 nF bypass capacitor at the VDD pins of the sensors;
- A 6.8 nF bypass capacitor at the AOUT and VREF pins of the sensors;
- A 1 nF bypass capacitor at the OCD1 and OCD2 pins of the sensors.

Additionally, OCD1 and OCD2 pins of the sensors are connected to 1 k Ω pull-up resistors, as they are open drain pins.

A voltage regulator is implemented to supply the sensors with a stable voltage.



5 System design

5.2 Layout

TLE4972 evaluation board consists of two 32 μm outer metallization layers and one 1 mm inner metallization layer. The inner layer is intended to carry the high current that is sensed by the sensors. Details are shown in the figure below.



Figure 6 Evaluation board layer stack up

The figure below shows the top and bottom layer of the evaluation board. Please contact your local Infineon sales office to receive the Gerber files.



5 System design

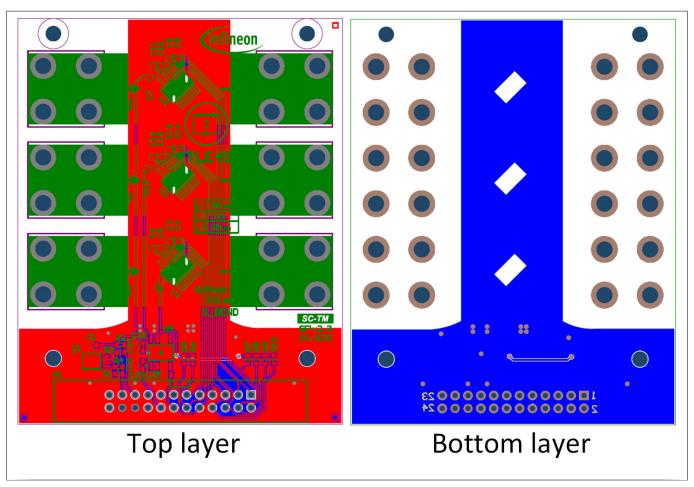


Figure 7 Evaluation board PCB layout (top and bottom layer)

AOUT and VREF tracks of each sensor are traced in parallel on the PCB in order to minimize the common mode noise on the output signal. Additionally, ground planes are used to protect the signal tracks and reduce the parasitic inductive couplings. The ground and power planes are cut below the TLE4972 including input and output pins to avoid the error induced due to the eddy currents. For the same reason, no heat sink or other conductor material shall be placed on the same position of the sensor.



5 System design

5.3 Bill of material

Table 2 Bill of Material

Quantity	Designator	Value	Footprint	Description
1	U5	-	SOIC-8	TLS208D1EJV33 (LDO)
3	U2, U3, U4	-	PG-TDSO-16	TLE4972 (current sensor)
1	U1	-	TSSOP8_W	M24C02-WDW6TP (EEPROM)
2	R3, R4	100 Ω ±1%	R0603	Resistors for EEPROM
8	R1, R2, R5, R6, R7, R8, R9, R10	1 kΩ ±1%	R0603	Pull-up resistors
1	P1	-	HDR2X12-Würth WR- BHD	Header, 24-Pin (2x12)
6	C5, C6, C10, C11, C15, C16	6.8 nF, 25V	C0603	AOUT and VREF capacitors
6	C3, C4, C8, C9, C13, C14	1 nF, 25V	C0603	OCD1/OCD2 capacitors
7	C1, C2, C7, C12, C21, C22, C25	220 nF, 25V	C0603	Bypass capacitors
2	C23, C24	22 μF, 10V	C0603	Bypass capacitors

5.4 Connector details

The evaluation board connector establishes the connection between the evaluation board and the programmer board. Please refer to the programmer user guide [1] for details about the programmer.

Table 3 Evaluation board connector pinout

Pin Number	Pin name	Pin function
1	AOUT1	Analog output voltage of sensor 1
2	OCD1_1	Over Current Detection channel 1 of sensor 1 (open drain)
3	VREF1	Reference voltage of sensor 1
4	OCD2_1	Over Current Detection channel 2 of sensor 1 (open drain)
5	AOUT2	Analog output voltage of sensor 2
6	OCD1_2	Over Current Detection channel 1 of sensor 2 (open drain)
7	VREF2	Reference voltage of sensor 2
8	OCD2_2	Over Current Detection channel 2 of sensor 2 (open drain)



5 System design

Table 3	(continued) Evaluation board connector pinout			
9	AOUT3	Analog output voltage of sensor 3		
10	OCD1_3	Over Current Detection channel 1 of sensor 3 (open drain)		
11	VREF3	Reference voltage of sensor 3		
12	OCD2_3	Over Current Detection channel 2 of sensor 3 (open drain)		
13	Reserved	Additional ADC input, connected to μC XMC4700 P14_7 on the programmer board		
14	VSENS	LDO enable signal. It can be shorted to V5 in order to enable the sensor supply		
15	Reserved	Additional ADC input, connected to μC XMC4700 P14_9 on the programmer board		
16	V5	5 V supply voltage		
17	Reserved	External trigger input, connected to µC XMC4700 P4_0 on the programmer board		
18	Reserved	-		
19	SCL	Clock for communication with external EEPROM on Infineon's evaluation boards		
20	GND	Ground connection		
21	SDA	Data link for communication with external EEPROM on Infineon's evaluation boards		
22	GND	Ground connection		
23	-	-		
24	Reserved	-		



6 System performance

System performance 6

6.1 **Test points**

The output voltage of the three sensors, as well as the OCD signals have been measured from the evaluation board connector. Please refer to Chapter 5.4 for the complete pinout of the evaluation board connector.

Test results 6.2

6.2.1 **Measurement results**

This section discusses the results of the measurements performed in the laboratory on the evaluation board. The following measurements have been performed:

- Sensitivity drift and offset drift over temperature 1.
- 2. Frequency response
- 3. Crosstalk
- 4. Thermal capability

6.2.1.1 Sensitivity drift and offset drift over temperature

The figures below show the TLE4972 evaluation board measurement results of sensitivity drift and offset over temperature when the sensor is placed in the nominal position. The results show extremely stable sensitivity and small offset across the whole temperature range. The absolute value of sensitivity used as target for calibration is shown in Chapter 3.4.

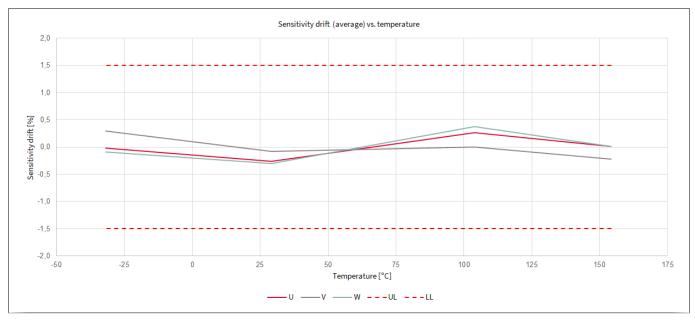


Figure 8 Sensitivity drift over temperature



6 System performance

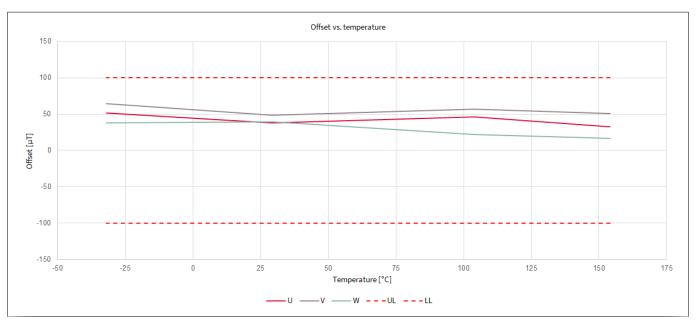


Figure 9 Offset over temperature

6.2.1.2 Frequency response

The figures below show the TLE4972 evaluation board measurement results of frequency response (gain and phase) when the sensor is placed in the nominal position. Two out of three sensors have been measured. A comparison with results from Finite Element Method (FEM) simulations is also provided. The Gain plots are normalized to the DC gain.

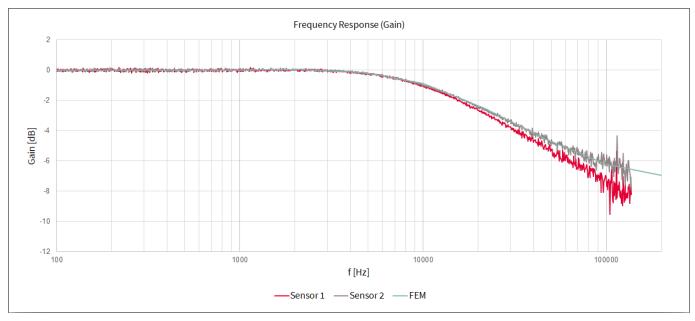


Figure 10 Frequency response (gain)



6 System performance

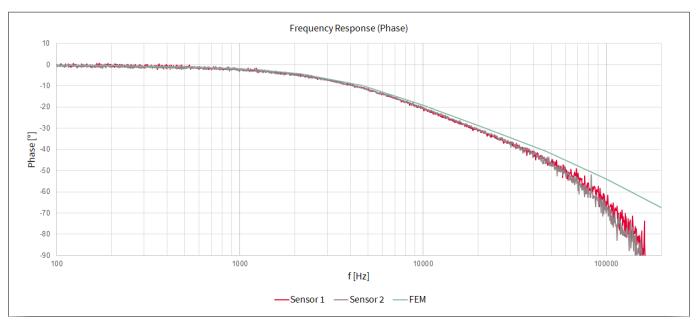


Figure 11 Frequency response (phase)

6.2.1.3 Crosstalk

The crosstalk is defined as the sensitivity error due to the magnetic stray field generated by the neighboring conductive lines. The crosstalk can be compensated with the "Matrix compensation method" in the microcontroller software. For further information, please refer to the programming board user guide [1] and device user manual [2].

Furthermore, the crosstalk can be reduced orienting the sensors differently with respect to each other, so that the respective sensing elements would see the same field coming from the neighboring conductive lines. Detailed explanation is provided in the application note [4].

The table below shows the sensitivity error due to the crosstalk before the compensation.

Table 4 Crosstalk

S [°			
Active phase	U	V	W
U	100,00	-1,14	-0,26
V	-1,18	100,00	-1,14
W	-0,27	-1,14	100,00



6 System performance

Thermal capability 6.2.1.4

The following figure shows the heating of the board and device when a current flows in the evaluation board. The temperature is read out by the sensor over time and the measurement is stopped when a temperature of approximately 80°C is detected. The measurement shows that a cooling of the board is needed, if high currents are applied.

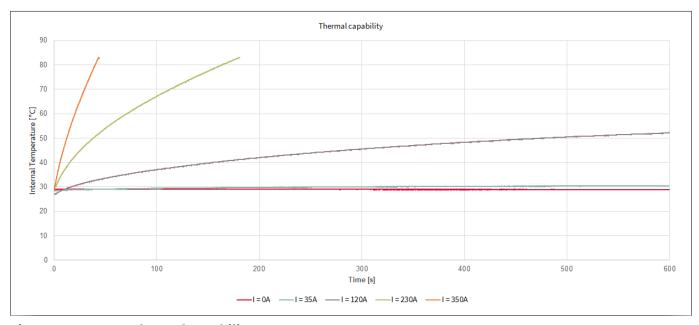


Figure 12 Thermal capability

6.2.2 Simulation results

This section discusses the results of the simulations performed in ANSYS Maxwell 3D on the evaluation board to complement the results from measurements. The following simulations have been performed:

- Conductor and insertion resistance 1.
- Transfer factor error due to sensor displacement 2.



6 System performance

6.2.2.1 Conductor and insertion resistance

The insertion resistance indicates the additional resistance caused by the sensing structure at 25°C. The simulations are performed with and without slit in the conductor by applying 1 A of current. Simulation results are shown in the figure below. Please note that the legend shows a voltage [V], which is equivalent to resistance $[\Omega]$, being the applied current 1 A.

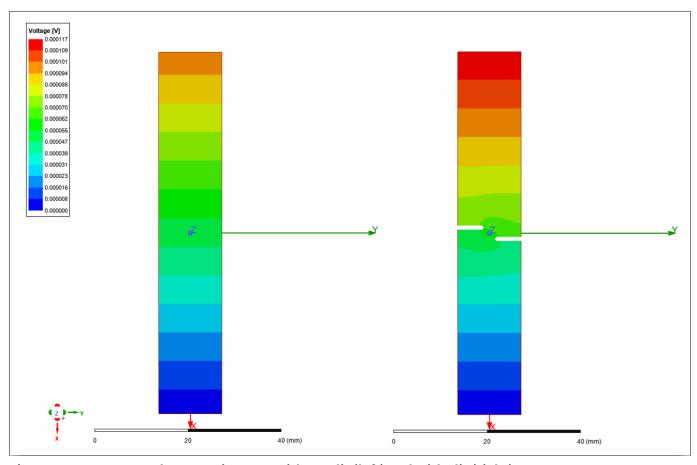


Figure 13 Conductor resistance, without slit (left) and with slit (right)

The table below shows the simulated resistance of the conductor with and without slit and the calculated insertion resistance.

Evaluation Board Conductor Resistance Table 5

Parameter	Value
Conductor resistance without slit	100 μΩ
Conductor resistance with slit	117 μΩ
Insertion resistance	17 μΩ
Conductor resistance increase	17%



6 System performance

6.2.2.2 Transfer factor error due to sensor displacement

This following figures show the transfer factor variation due to sensor displacement in the x, y, and z-axis direction. The transfer factor is defined in μ T/A and the typical value is shown in Chapter 3.4.

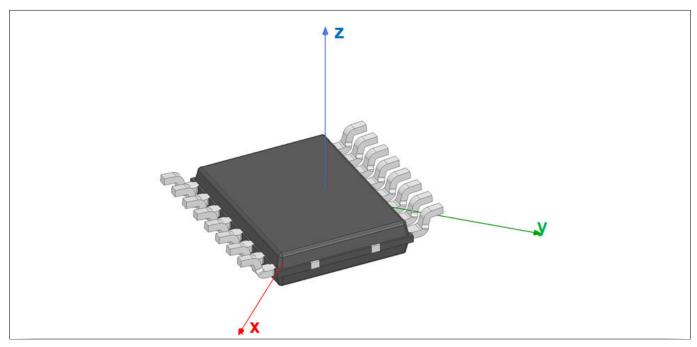


Figure 14 Reference system for sensor displacement simulations



Figure 15 Transfer factor error due to sensor displacement in x direction



6 System performance

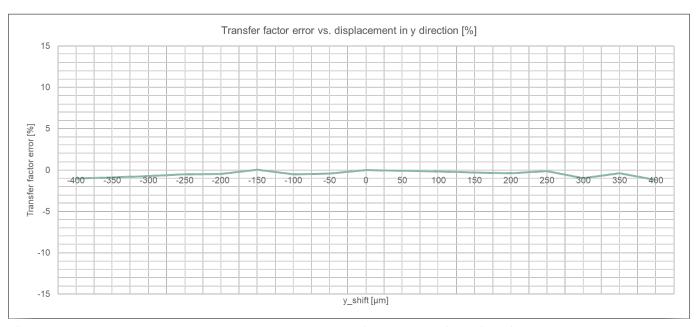


Figure 16 Transfer factor error due to sensor displacement in y direction

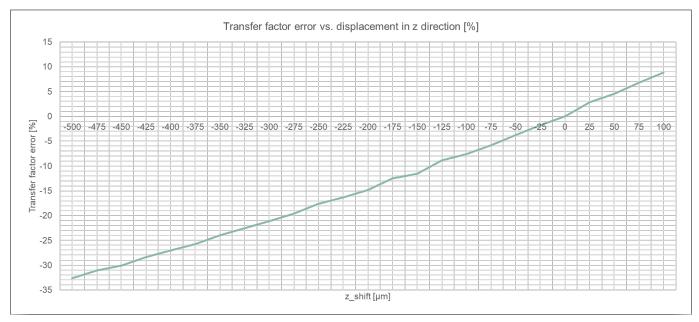


Figure 17 Transfer factor error due to sensor displacement in z direction



7 References and appendices

7 References and appendices

7.1 Abbreviations and definitions

Notation	Description
AC	Alternating Current
CE	European Conformity
DC	Direct Current
EMC	Electro-Magnetic Compatibility
EMI	Electro-Magnetic Interference
EEPROM	Electrically Erasable Programmable Read-Only Memory
ESD	Electro-Static Discharge
FEM	Finite Element Method
GUI	Graphical User Interface
LDO	Low Drop Out
LV	Low Voltage
OCD	Over Current Detection
PCB	Printed Circuit Board
PCN	Process Change Notification
PD	Product Discontinuation
PWD	Product Withdraw
RMA	Returned Material Analysis
SCL	Serial Clock
SDA	Serial Data
UL	Underwriters Laboratories
USB	Universal Serial Bus

7.2 References

- [1] Infineon-TLE4972-Current_Sensor_Programmer_User_guide-vxx_xx-EN
- [2] Infineon-TLE4972-User_manual-vxx_xx-EN
- [3] Infineon-TLE4972AE35S5-DS-vxx_xx-EN, Infineon-TLE4972AE35D5-DS-vxx_xx-EN
- [4] Infineon-TLE4972-Sensing_Structure_Design-AN-vxx_xx-EN



8 Revision history

8 Revision history

Table 6 Revision History

Document version	Date of release	Description of changes
1.1	2023-02-28	- In order to enable sensor supply, pin 16 and 14 of connector P1 must be connected to 5 V;
		- Fixed error in transfer factor error due to sensor displacement plots; - Editorial changes.
1.0	2022-04-14	Initial release

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